

BB187

VHF variable capacitance diode

Rev. 04 — 3 November 2004

Product data sheet

1. Product profile

1.1 General description

The BB187 is a planar technology variable capacitance diode, in a SOD523 (SC-79) ultra small plastic SMD package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

1.2 Features

- High linearity
- Excellent matching to 2 % DMA
- Ultra small plastic SMD package
- $C_{d(25V)}$: 2.75 pF; $C_{d(2V)}$ to $C_{d(25V)}$ ratio: minimum 11
- Low series resistance.

1.3 Applications

- Electronic tuning in VHF television tuners
- Voltage Controlled Oscillators (VCO).

2. Pinning information

Table 1: Pinning

Pin	Description	Simplified outline [1]	Symbol
1	cathode	 Top view	 <i>sym008</i>
2	anode		

[1] The marking bar indicates the cathode.

3. Ordering information

Table 2: Ordering information

Type number	Package		Version
	Name	Description	
BB187	SC-79	plastic surface mounted package; 2 leads	SOD523

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4. Marking

Table 3: Marking

Type number	Marking code
BB187	X

5. Limiting values

Table 4: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

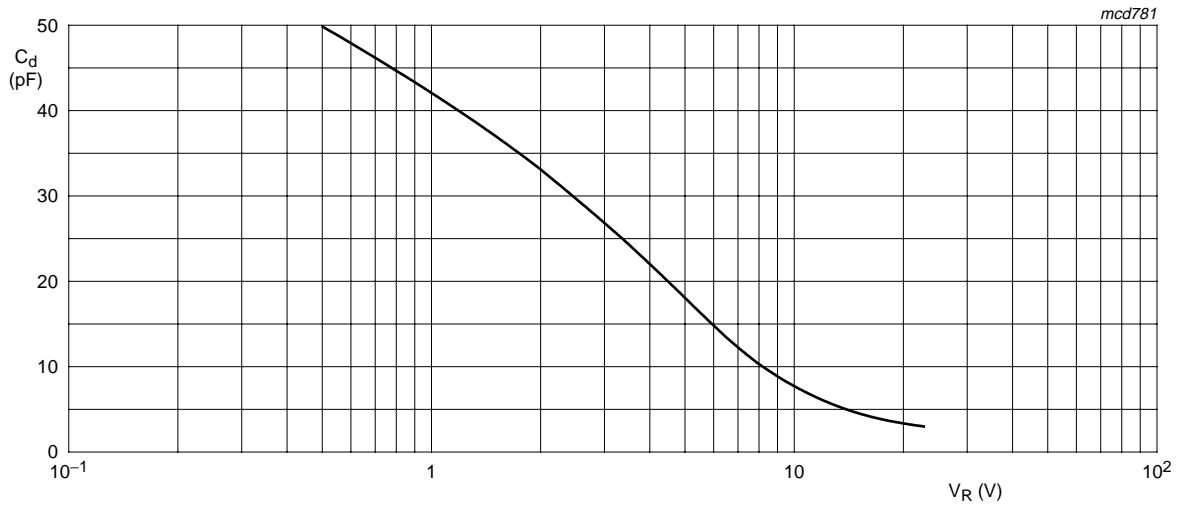
Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	32	V
V_{RM}	peak reverse voltage	in series with a 10 k Ω resistor	-	35	V
I_F	forward current		-	20	mA
T_{stg}	storage temperature		-55	+150	$^{\circ}\text{C}$
T_j	junction temperature		-55	+125	$^{\circ}\text{C}$

6. Characteristics

Table 5: Characteristics

$T_j = 25^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_R	reverse current	see Figure 2	-	-		
		$V_R = 30\text{ V}$	-	-	10	nA
		$V_R = 30\text{ V}; T_j = 85^{\circ}\text{C}$	-	-	200	nA
r_s	diode series resistance	$f = 470\text{ MHz}; V_R = 5\text{ V}$	-	-	0.75	Ω
C_d	diode capacitance	$f = 1\text{ MHz}$; see Figure 1 and Figure 3				
		$V_R = 2\text{ V}$	29.3	-	34.2	pF
		$V_R = 25\text{ V}$	2.57	2.75	2.92	pF
$\frac{C_{d(2V)}}{C_{d(25V)}}$	capacitance ratio	$f = 1\text{ MHz}$	11	-	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 2\text{ V to } 25\text{ V}$; in a sequence of 10 diodes (gliding)	-	-	2	%



$f = 1 \text{ MHz}; T_j = 25 \text{ }^\circ\text{C}.$

Fig 1. Diode capacitance as a function of reverse voltage; typical values.

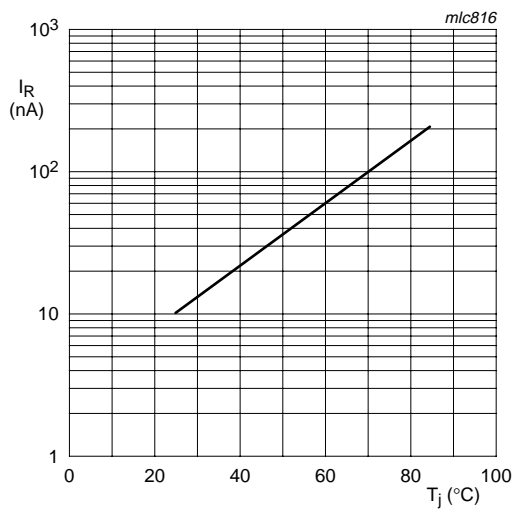


Fig 2. Reverse current as a function of junction temperature; maximum values.

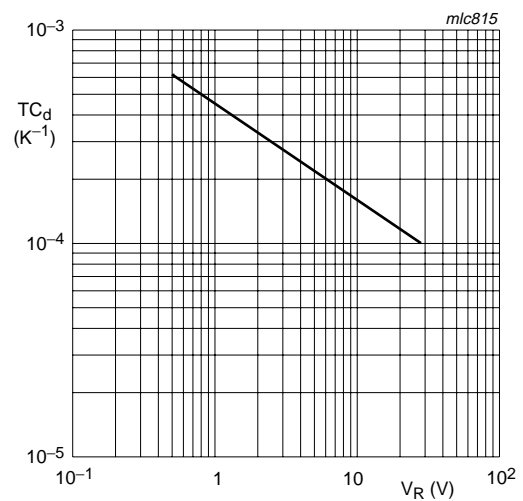


Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

7. Package outline

Plastic surface mounted package; 2 leads

SOD523

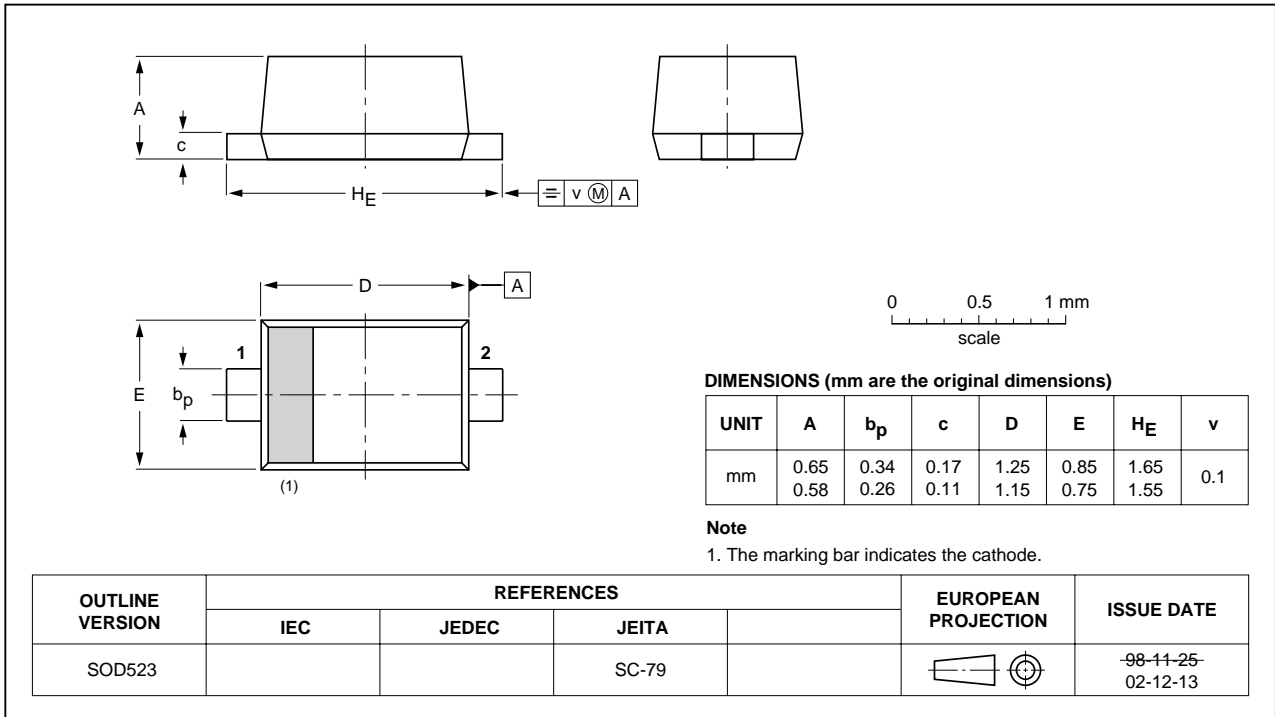


Fig 4. Package outline SOD523 (SC-79).

8. Revision history

Table 6: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
BB187_4	20041103	Product data sheet	-	9397 750 13835	BB187_3
Modifications:					
			<ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors Table 5 “Characteristics”: $\Delta C_d/C_d$ conditions changed from sequence of 15 diodes to sequence of 10 diodes Table 5 “Characteristics”: added typical value of 2.75 pF for $C_{d(25V)}$. 		
BB187_3	20020220	Product specification	-	9397 750 09385	BB187_2
BB187_2	19991019	Product specification	-	9397 750 06459	BB187_1
BB187_1	19990915	Preliminary specification	-	9397 750 06307	-

9. Data sheet status

Level	Data sheet status ^[1]	Product status ^[2] ^[3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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For sales office addresses, send an email to: sales.addresses@www.semiconductors.philips.com

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